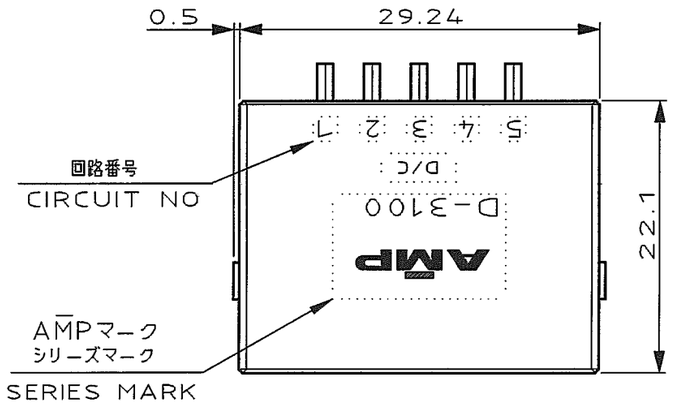
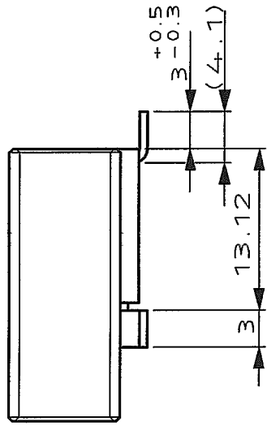
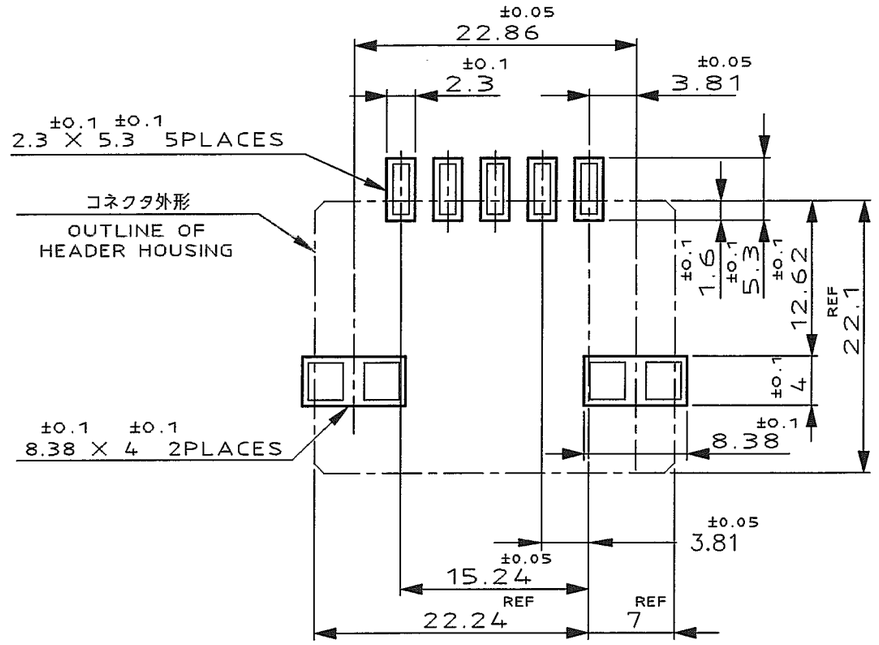


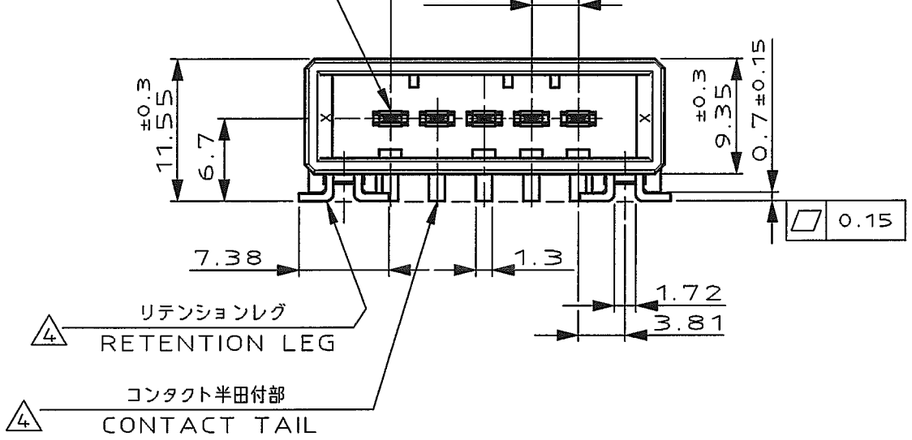




推奨基板取付け寸法

（非累積公差）
（コネクタ搭載面）

RECOMEND BOARD PATTERN
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)



NOTES

1. MATERIAL:HOUSING:GLASS FILED THERMO PLASTIC ,UL94V-0
   CONTACT:COPPER ALLOY
   RETENTION LEG:COPPER ALLOY
2. FINISH(CONTACT AREA):0.38μmMIN GOLD PLATING OVER Ni PLATING
3. FINISH(CONTACT AREA):0.76μmMIN GOLD PLATING OVER Ni PLATING
4. FINISH(RETENTION LEG): TIN PLATED (SOLDER TYING) OVER NICKEL

注記

1. 材料：ハウジング：ガラス入り熱可塑性樹脂 ,UL94V-0
   コンタクト：銅合金
   リテンションレグ：銅合金
2. めっき：コンタクト接触部：ニッケル下地の上に金めっき0.38μmMIN
3. めっき：コンタクト接触部：ニッケル下地の上に金めっき0.76μmMIN
4. めっき：リテンションレグとコンタクト半田付部：ニッケル下地の上にスズめっき

4 3	1-177662-3
4 2	1-177662-2
(FINISH)	製品番号 (PART NO.)

LTR	REVISION RECORD	DR	CHK	DATE
A	REVISED(FJD0-0039-03)	TS	S.M	6/2 '93
0	RELEASED (FJ00-0284-93)	NM	SM	9/30

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tyco Electronics

Tyco Electronics AMP K.K.
Kawasaki,Japan

WIRE RANGE mm²(AWG -)	INSULATION DIA — mmφ
MATERIAL SEE NOTE 注記参照	FINISH SEE NOTE 注記参照
DR. 20 SEP 93 N.Matsukara	DE. 20 SEP 93 N.Matsukara
CHK. 30 SEP 93 S.MANABE	APP. 30 SEP 93 S.MANABE

NAME
5 POS SINGLE ROW SMT TYPE
HORIZONTAL HDR ASS'Y FOR DYNAMIC 3100

一般公差 (GENERAL TOLERANCE)	SIZE	LOC	NUMBER
10以下 ： ±0.2 10を超え 30以下 ： ±0.3 30を超え100以下 ： ±0.4 角 度 ： ±3°	A3	J	C-177662
	SCALE 2-1	REV. A	SHEET 1 OF 1

(CUSTOMER DRAWING) 顧客用図面

NUMBER 177662
3rd ANGLE PROJECTION
METRIC
PROJ NO.392-610
DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT
PRINT DIST

AMP-J
REV.10/'83